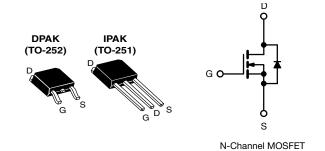


Vishay Siliconix

Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V)	200			
R _{DS(on)} (Ω)	V _{GS} = 10 V 1.5			
Q _g max. (nC)	8.2			
Q _{gs} (nC)	1.8			
Q _{gd} (nC)	4.5			
Configuration	Single			

FEATURES

- Dynamic dV/dt rating
- Repetitive avalanche rated
- Surface-mount (IRFR210, SiHFR210)
- Straight lead (IRFU210, SiHFU210)
- Available in tape and reel
- Fast switching
- Ease of paralleling
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRFU, SiHFU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface mount applications.

ORDERING INFORMATION						
PACKAGE	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)	
Lead (Pb)-free and halogen-free	SiHFR210-GE3	SiHFR210TRL-GE3 ^a	-	SiHFR210TRR-GE3 ª	SiHFU210-GE3	
Lead (Pb)-free	IRFR210PbF	IRFR210TRLPbF ^a	IRFR210TRPbF ^a	IRFR210TRRPbF	IRFU210PbF	
Lead (Pb)-free and halogen-free	IRFR210PbF-BE3 ab	IRFR210TRLPbF-BE3 ab	IRFR210TRPbF-BE3 ab	-	-	

Notes

a. See device orientation

b. "-BE3" denotes alternate manufacturing location

ABSOLUTE MAXIMUM RATINGS (T C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	200	V
Gate-source voltage			V _{GS}	± 20	V
Continuous drain surrent $T_{\rm C} = 25 ^{\circ}{\rm C}$			2.6		
Continuous drain current V_{GS} at 10 V $\frac{T_C = 25 \degree C}{T_C = 100 \degree C}$			I _D	1.7	А
Pulsed drain current ^a			I _{DM}	10	
Linear derating factor				0.20	W/°C
Linear derating factor (PCB mount) ^e				0.020	W/ C
Single pulse avalanche Energy ^b			E _{AS}	95	mJ
Avalanche current ^a			I _{AR}	2.7	А
Repetitive avalanche energy ^a			E _{AR}	2.5	mJ
Maximum power dissipation $T_{\rm C} = 25 ^{\circ}{\rm C}$			Р	25	w
Maximum power dissipation (PCB mount) ^e	$T_A = 25 \degree C$ P_D		гD	2.5	vv
Peak diode recovery dV/dt ^c			dV/dt	5.0	V/ns
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Soldering recommendations (peak temperature) ^d for 10 s				260	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28 mH, R_g = 25 Ω , I_{AS} = 2.6 A (see fig. 12)

c. $I_{SD} \le 2.6$ A, $dI/dt \le 70$ A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C

d. 1.6 mm from case

e. When mounted on 1" square PCB (FR-4 or G-10 material)

S21-0373-Rev. F, 19-Apr-2021

1

ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishav.com/doc?91000







Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R _{thJA}	-	-	110	
Maximum junction-to-ambient (PCB mount) ^a	R _{thJA}	-	-	50	°C/W
Maximum junction-to-case (drain)	R _{thJC}	-	-	5.0	

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material)

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		L			<u> </u>	<u> </u>	
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μΑ	200	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 1 mA	-	0.30	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Gate-source leakage	I _{GSS}	,	V _{GS} = ± 20 V	-	-	± 100	nA
Zaus asta usltana dusia suuraat		V _{DS} =	= 200 V, V _{GS} = 0 V	-	-	25	
Zero gate voltage drain current	IDSS	V _{DS} = 160 V	′, V _{GS} = 0 V, T _J = 125 °C	-	-	250	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 1.6 A ^b	-	-	1.5	Ω
Forward transconductance	9 _{fs}	V _{DS} =	50 V, I _D = 1.6 A ^b	0.80	-	-	S
Dynamic				•	•	•	
Input capacitance	C _{iss}		$V_{GS} = 0 V$,	-	140	-	pF
Output capacitance	Coss		$V_{DS} = 25 V,$	-	53	-	
Reverse transfer capacitance	C _{rss}	f = 1.	0 MHz, see fig. 5	-	15	-	
Total gate charge	Qg	V _{GS} = 10 V I _D = 3.3 A, V _{DS} = 160 V, see fig. 6 and 13 ^b		-	-	8.2	nC
Gate-source charge	Q _{gs}			-	-	1.8	
Gate-drain charge	Q _{gd}		see lig. 6 and 13 ~		-	4.5	
Turn-on delay time	t _{d(on)}			-	8.2	-	
Rise time	tr	V_{DD} = 100 V, I _D = 3.3 A, R _g = 24 Ω , R _D = 30 Ω , see fig. 10 ^b		-	17	-	- ns
Turn-off delay time	t _{d(off)}			-	14	-	
Fall time	t _f			-	8.9	-	
Internal drain inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	
Internal source inductance	L _S			-	7.5	-	nH
Drain-source body diode characteristics	;	•					
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	2.6	
Pulsed diode forward current ^a	I _{SM}			-	-	10	A
Body diode voltage	V _{SD}	$T_{\rm J} = 25 ^{\circ}\text{C}, I_{\rm S} = 2.6 \text{A}, V_{\rm GS} = 0 \text{V}^{\text{b}}$		-	-	2.0	V
Body diode reverse recovery time	t _{rr}	T 25 °C I	- 3 3 A dl/dt - 100 A/uph	-	150	310	ns
Body diode reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = 3.3 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}^{\text{b}}$		-	0.60	1.4	μC
Forward turn-on time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L _D)			L _D)		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 µs; duty cycle \leq 2 %

2

VISHAY. www.vishay.com

IRFR210, IRFU210, SiHFR210, SiHFU210

Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

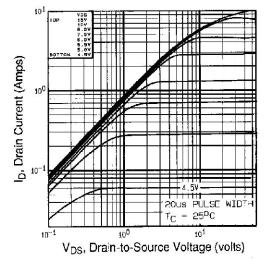


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

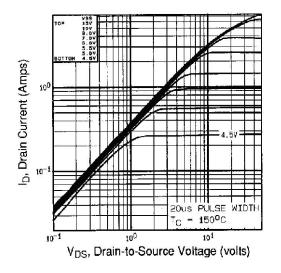


Fig. 1 - Typical Output Characteristics, T_C = 150 °C

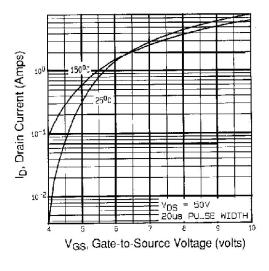


Fig. 2 - Typical Transfer Characteristics

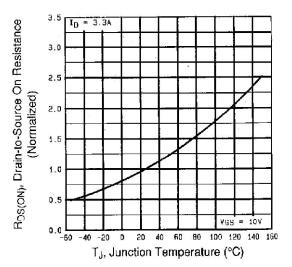


Fig. 3 - Normalized On-Resistance vs. Temperature



Vishay Siliconix

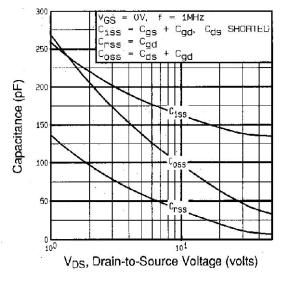
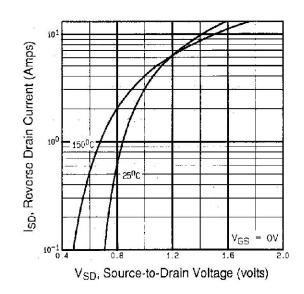
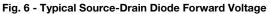


Fig. 4 - Typical Capacitance vs. Drain-to-Source Voltage





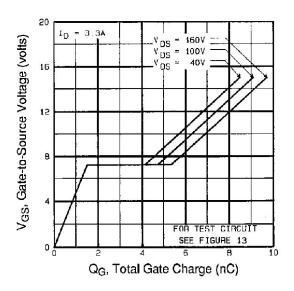
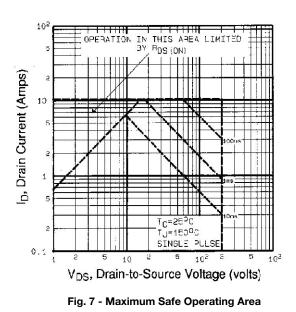


Fig. 5 - Typical Gate Charge vs. Gate-to-Source Voltage





Vishay Siliconix

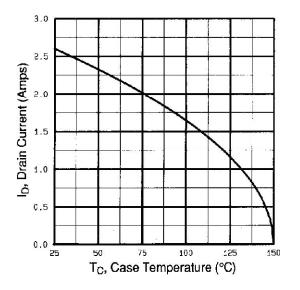


Fig. 8 - Maximum Drain Current vs. Case Temperature

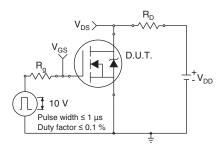


Fig. 10a - Switching Time Test Circuit

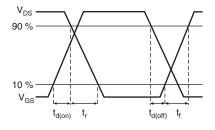


Fig. 10b - Switching Time Waveforms

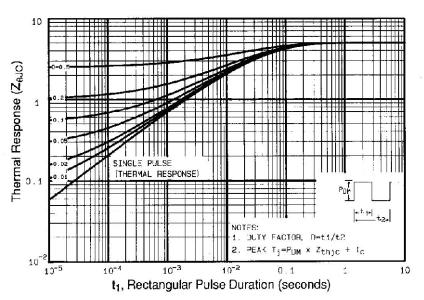


Fig. 9 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

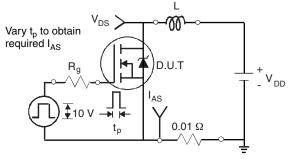


Fig. 12a - Unclamped Inductive Test Circuit

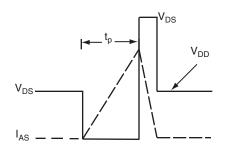


Fig. 12b - Unclamped Inductive Waveforms

S21-0373-Rev. F, 19-Apr-2021

5 Sujections contact: hym@ Document Number: 91268

For technical questions, contact: <u>hvm@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT <u>www.vishay.com/doc?91000</u>



Vishay Siliconix

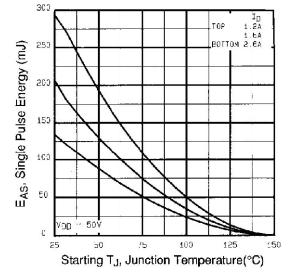


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

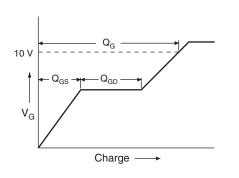


Fig. 13a - Basic Gate Charge Waveform

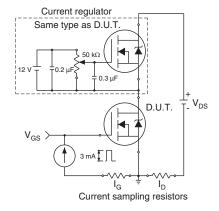
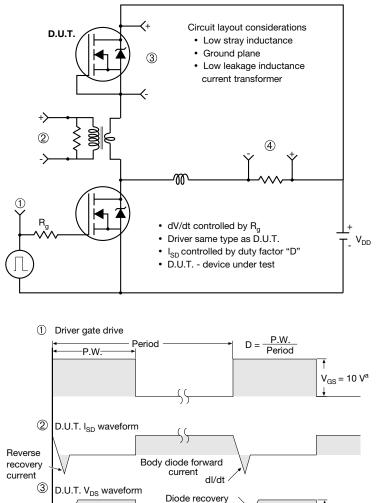


Fig. 13b - Gate Charge Test Circuit



Vishay Siliconix

Peak Diode Recovery dV/dt Test Circuit



Re-applied voltage (4) Inductor current Body diode forward drop Inductor current Ripple $\leq 5 \%$

Note

a. $V_{GS} = 5$ V for logic level devices

Fig. 10 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91268.

7





TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







	MILLIMETERS		
DIM.	MIN.	MAX.	
А	2.18	2.38	
A1	-	0.127	
b	0.64	0.88	
b2	0.76	1.14	
b3	4.95	5.46	
С	0.46	0.61	
C2	0.46	0.89	
D	5.97	6.22	
D1	4.10	-	
E	6.35	6.73	
E1	4.32	-	
Н	9.40	10.41	
е	2.28 BSC		
e1	4.56 BSC		
L	1.40	1.78	
L3	0.89	1.27	
L4	- 1.02		
L5	1.01	1.52	

Note

• Dimension L3 is for reference only



Vishay Siliconix

VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
A	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
С	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	-	
E	6.35	6.73	
E1	4.32 -		
е	2.29 BSC		
Н	9.94	10.34	

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74	l ref.	
L2	0.51	BSC	
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25° 35°		

Notes

• Dimensioning and tolerance confirm to ASME Y14.5M-1994

• All dimensions are in millimeters. Angles are in degrees

• Heat sink side flash is max. 0.8 mm

Radius on terminal is optional

ECN: E19-0649-Rev. Q, 16-Dec-2019 DWG: 5347



Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by Vishay manufacturer:

Other Similar products are found below :

614233C 648584F IRFD120 JANTX2N5237 2N7000 FCA20N60_F109 FDZ595PZ 2SK2545(Q,T) 405094E 423220D TPCC8103,L1Q(CM MIC4420CM-TR VN1206L 614234A 715780A NTNS3166NZT5G SSM6J414TU,LF(T 751625C IPS70R2K0CEAKMA1 BUK954R8-60E DMN3404LQ-7 NTE6400 SQJ402EP-T1-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI DMN1017UCP3-7 EFC2J004NUZTDG ECH8691-TL-W FCAB21350L1 P85W28HP2F-7071 DMN1053UCP4-7 NTE221 NTE2384 NTE2903 NTE2941 NTE2945 NTE2946 NTE2960 NTE2967 NTE2969 NTE2976 NTE455 NTE6400A NTE2910 NTE2916 NTE2956 NTE2911 US6M2GTR TK10A80W,S4X(S SSM6P69NU,LF